VBQA1603



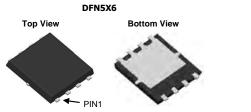
N-Channel 60 V (D-S) MOSFET

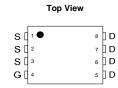
| PRODUCT SUMMARY | | | | |
|---------------------|----------------------------------|---------------------------------|--|--|
| V _{DS} (V) | R _{DS(on)} (Ω) | I _D (A) ^a | | |
| 60 | 0.003 at V _{GS} = 10 V | 100 | | |
| | 0.005 at V _{GS} = 4.5 V | 85 | | |

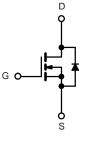
FEATURES

- 175 °C Junction Temperature
- TrenchFET[®] Power MOSFET
- Material categorization:









N-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS ($T_C =$ | 25 °C, unless othe | rwise noted) | | |
|---|-------------------------|-----------------------------------|--------------------------------------|----|
| Parameter | Symbol | Limit | Unit | |
| Gate-Source Voltage | | V _{GS} | ± 20 | V |
| Continuous Durin Coursent (T. 475 °C)b | T _C = 25 °C | 1 | 100 | |
| Continuous Drain Current (T _J = 175 °C) ^b | T _C = 100 °C | I _D | 85 ^a | |
| Pulsed Drain Current | I _{DM} | 100 | А | |
| Continuous Source Current (Diode Conduction) | ۱ _S | 80 ^a | | |
| Avalanche Current | I _{AS} | 70 | | |
| Single Avalanche Energy (Duty Cycle \leq 1 %) | L = 0.1 mH | E _{AS} | 125 | mJ |
| Movimum Dower Dissinction | T _C = 25 °C | D | 136 | w |
| Maximum Power Dissipation | T _A = 25 °C | P _D | 3 ^b , 8.3 ^{b, c} | vv |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | - 55 to 175 | °C |

| THERMAL RESISTANCE RATINGS | | | | | | |
|--|------------------------|-------------------|---------|---------|------|--|
| Parameter | | Symbol | Typical | Maximum | Unit | |
| Mauinung lungting to Archingta | $t \le 10 \text{ sec}$ | R _{thJA} | 15 | 18 | °C/W | |
| Maximum Junction-to-Ambient ^a | Steady State | | 40 | 50 | | |
| Maximum Junction-to-Case | | R _{thJC} | 0.85 | 1.1 | | |

Notes:

a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

c. t \leq 10 s.



| Parameter | Symbol | Test Conditions | Min. | Typ. ^a | Max. | Unit | | |
|---|---------------------|---|------|-------------------|-------|------|--|--|
| Static | 1 | | 1 | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 V, I_D = 250 \mu A$ | 60 | | | V | | |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = 250 \ \mu A$ | 1 | 2 | 3 | v | | |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 V, V_{GS} = \pm 20 V$ | | | ± 100 | nA | | |
| | | $V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$ | | | 1 | | | |
| Zero Gate Voltage Drain Current | I _{DSS} | $V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$ | 50 | | | μA | | |
| | | V _{DS} = 60 V, V _{GS} = 0 V, T _J = 175 °C | | | 250 | 1 | | |
| On-State Drain Current ^b | I _{D(on)} | $V_{DS} = 5 V, V_{GS} = 10 V$ | 60 | | | А | | |
| | | V _{GS} = 10 V, I _D = 20 A | | 0.003 | 0.003 | | | |
| - · | Б | V _{GS} = 10 V, I _D = 20 A, T _J = 125 °C | | 0.008 | Ω | | | |
| Drain-Source On-State Resistance ^b | R _{DS(on)} | V _{GS} = 10 V, I _D = 20 A, T _J = 175 °C | | 0.010 | 2 | | | |
| | | V _{GS} = 4.5 V, I _D = 15 A | | 0.013 | | 1 | | |
| Forward Transconductance ^b | 9 _{fs} | V _{DS} = 15 V, I _D = 20 A | | 60 | | S | | |
| Dynamic | 1 | | 1 | | | | | |
| Input Capacitance | C _{iss} | | | 2650 | | pF | | |
| Output Capacitance | C _{oss} | V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz | | 470 | | | | |
| Reverse Transfer Capacitance | C _{rss} | | | 225 | | | | |
| Total Gate Charge ^c | Qg | | | 47 | 70 | nC | | |
| Gate-Source Charge ^c | Q _{gs} | $V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 50 \text{ A}$ | | 10 | | | | |
| Gate-Drain Charge ^c | Q _{gd} | | | 12 | | 1 | | |
| Turn-On Delay Time ^c | t _{d(on)} | | | 10 | 20 | | | |
| Rise Time ^c | t _r | $V_{DD} = 30 \text{ V}, \text{ R}_{L} = 0.6 \Omega$ | | 15 | 25 | | | |
| Turn-Off Delay Time ^c | t _{d(off)} | $I_D \cong 50 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 2.5 \Omega$ | | 35 | 50 | ns | | |
| Fall Time ^c | t _f | | | 20 | 30 | | | |
| Source-Drain Diode Ratings and Cha | aracteristics (| T _C = 25 °C) | | | I | | | |
| Pulsed Current | I _{SM} | | | | 60 | А | | |
| Diode Forward Voltage | V _{SD} | I _F = 20 A, V _{GS} = 0 V | | 1 | 1.5 | V | | |
| Reverse Recovery Time | t _{rr} | I _F = 20 A, di/dt = 100 A/μs | | 45 | 100 | ns | | |

Notes:

a. For design aid only; not subject to production testing.

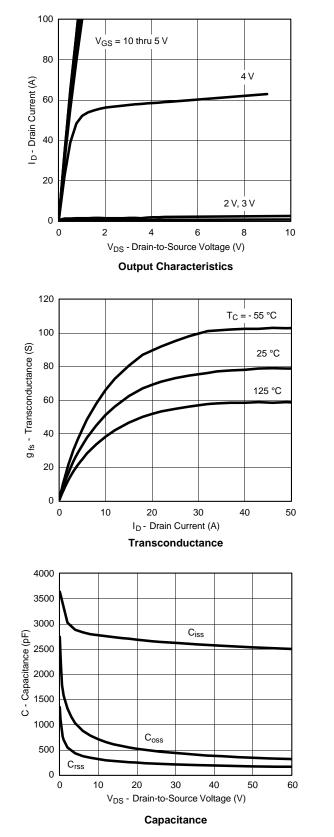
b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

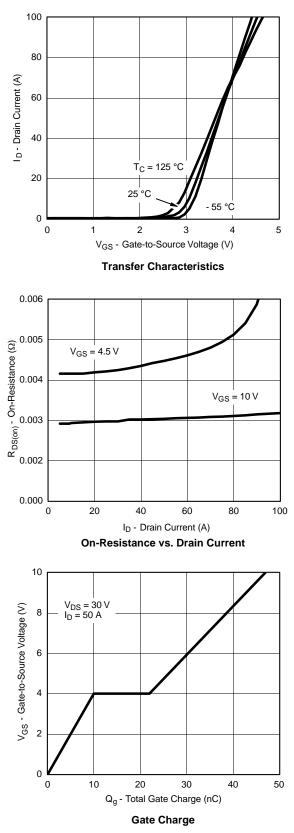
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

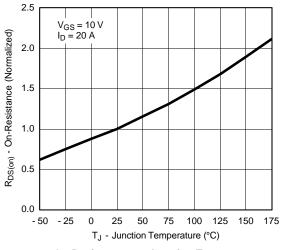






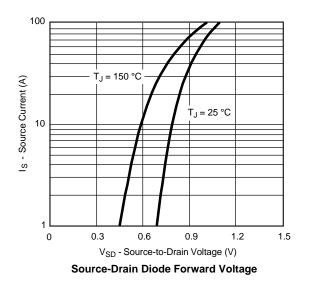






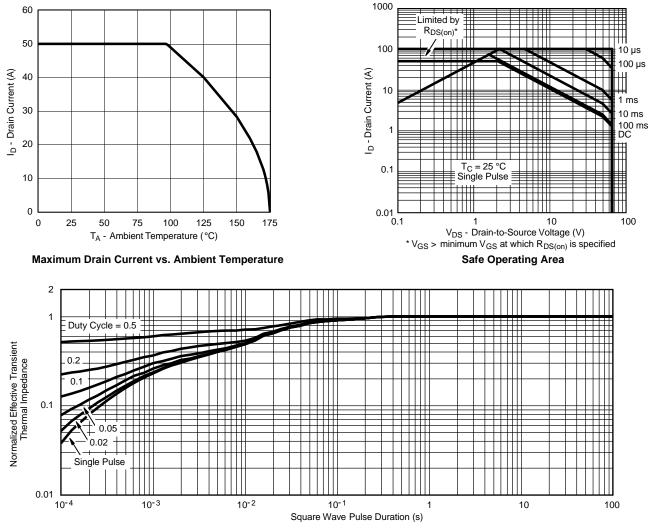
TYPICAL CHARACTERISTICS (25 °C unless noted)

On-Resistance vs. Junction Temperature





THERMAL RATINGS

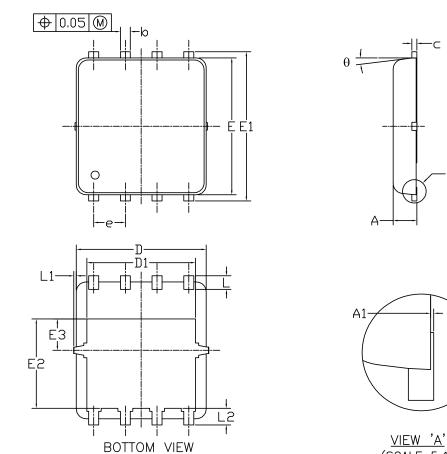


Normalized Thermal Transient Impedance, Junction-to-Case



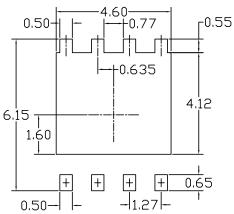
С

VIEW 'A'



DFN5x6_8L_EP1_P PACKAGE OUTLIN

RECOMMENDED LAND PATTERN



| SYMBOLS | DIMENSIONS IN MILLIMETERS | | | DIMENSIONS IN INCHES | | |
|---------|---------------------------|-------|-------|----------------------|-------|-------|
| STMBOLS | MIN | NOM | MAX | MIN | NOM | MAX |
| Α | 0.85 | 0.95 | 1.00 | 0.033 | 0.037 | 0.039 |
| Al | 0.00 | | 0.05 | 0.000 | | 0.002 |
| b | 0.30 | 0.40 | 0.50 | 0.012 | 0.016 | 0.020 |
| с | 0.15 | 0.20 | 0.25 | 0.006 | 0.008 | 0.010 |
| D | 5.10 | 5.20 | 5.30 | 0.201 | 0.205 | 0.209 |
| D1 | 4.25 | 4.35 | 4.45 | 0.167 | 0.171 | 0.175 |
| Е | 5.45 | 5.55 | 5.65 | 0.215 | 0.219 | 0.222 |
| E1 | 5.95 | 6.05 | 6.15 | 0.234 | 0.238 | 0.242 |
| E2 | 3.525 | 3.625 | 3.725 | 0.139 | 0.143 | 0.147 |
| E3 | 1.175 | 1.275 | 1.375 | 0.046 | 0.050 | 0.054 |
| e | 1.27 BSC | | | 0.050 BSC | | |
| L | 0.45 | 0.55 | 0.65 | 0.018 | 0.022 | 0.026 |
| L1 | 0 | | 0.15 | 0 | | 0.006 |
| L2 | 0.68 REF | | | 0.027 REF | | |
| θ | 0° | | 10° | 0° | | 10° |

(SCALE 5:1)

NOTE

UNIT: mm

1. PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS. MOLD FLASH AT THE NON-LEAD SIDES SHOULD BE LESS THAN 6 MILS EACH. 2. CONTROLLING DIMENSION IS MILLIMETER.

CONVERTED INCH DIMENSIONS ARE NOT NECESSARILY EXACT.



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